

High performance lasers on Si

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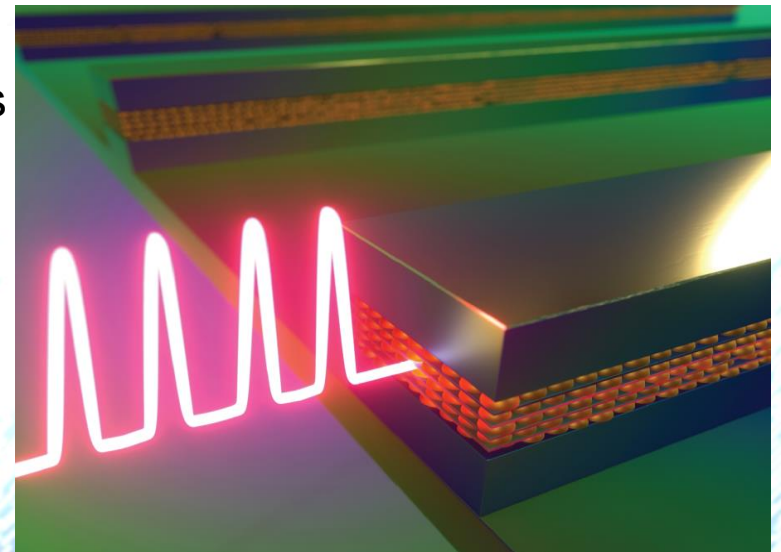
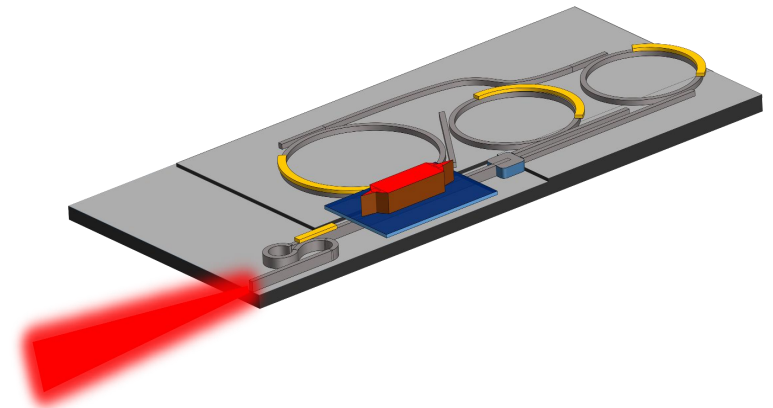
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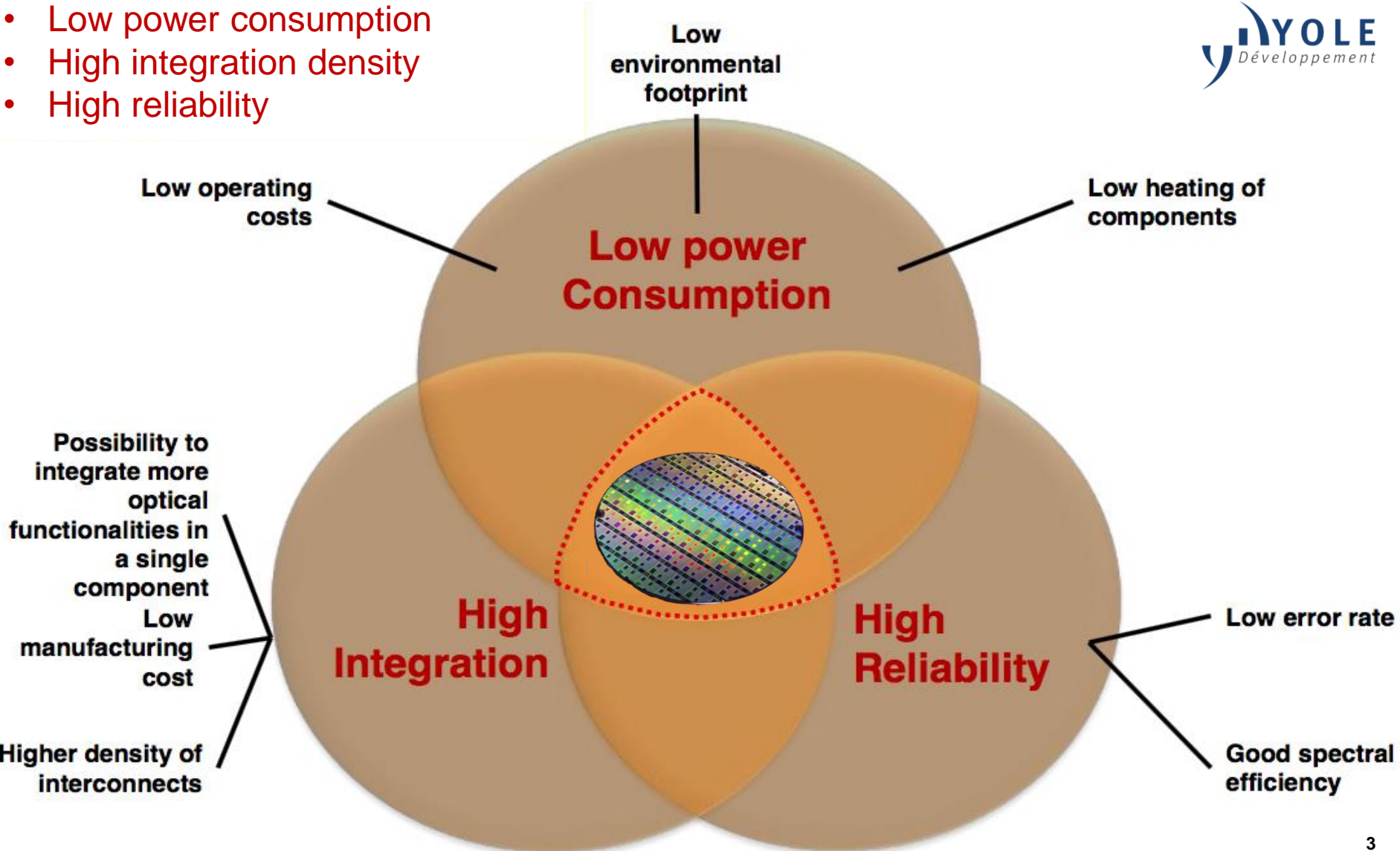
Outline

- Motivation
- Heterogeneous integration
 - Sub-kHz optical linewidth lasers
- Direct epitaxial growth
 - Low-noise high-channel-count comb lasers
- Summary



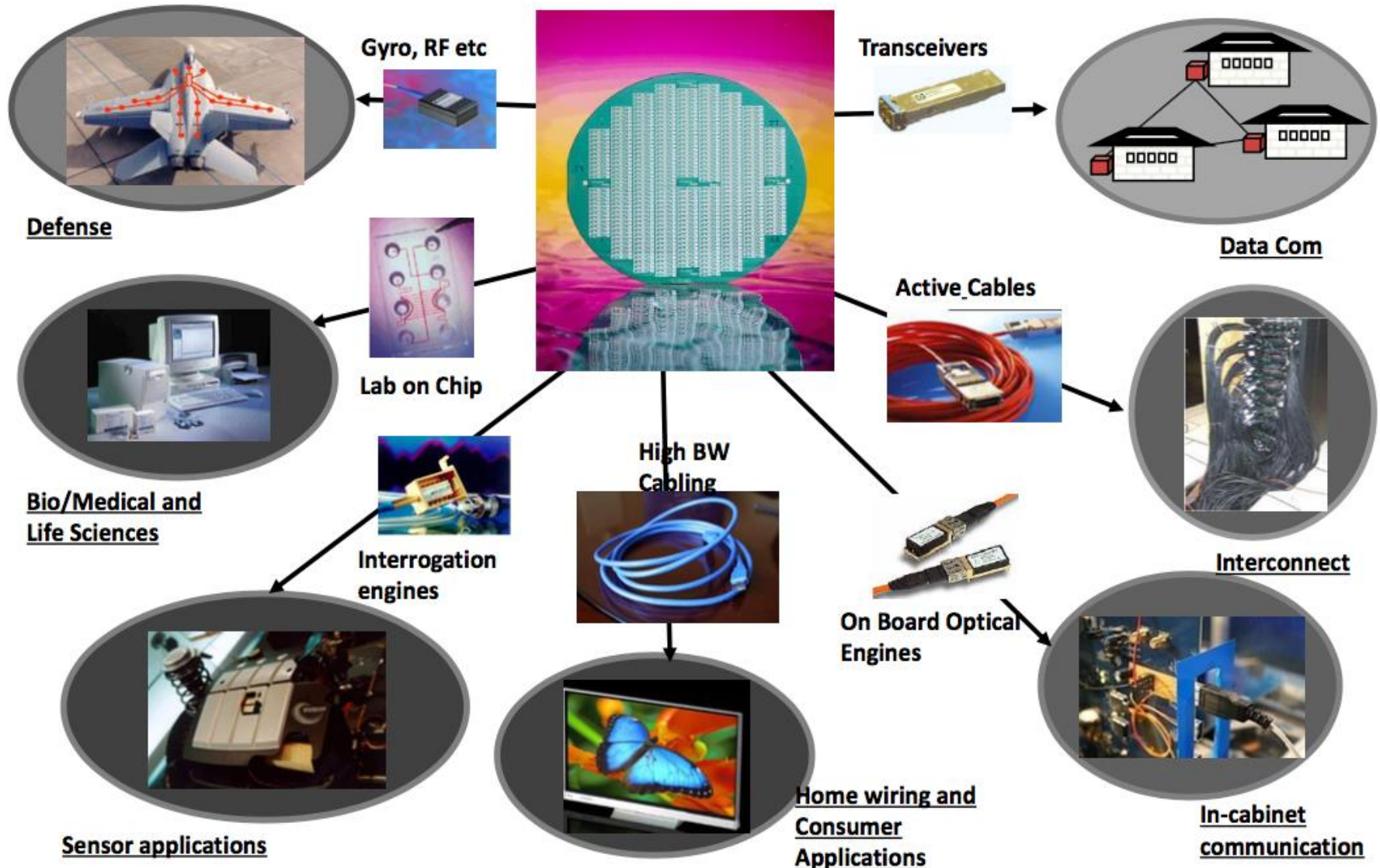
Advantages of Si photonics

- Low power consumption
- High integration density
- High reliability



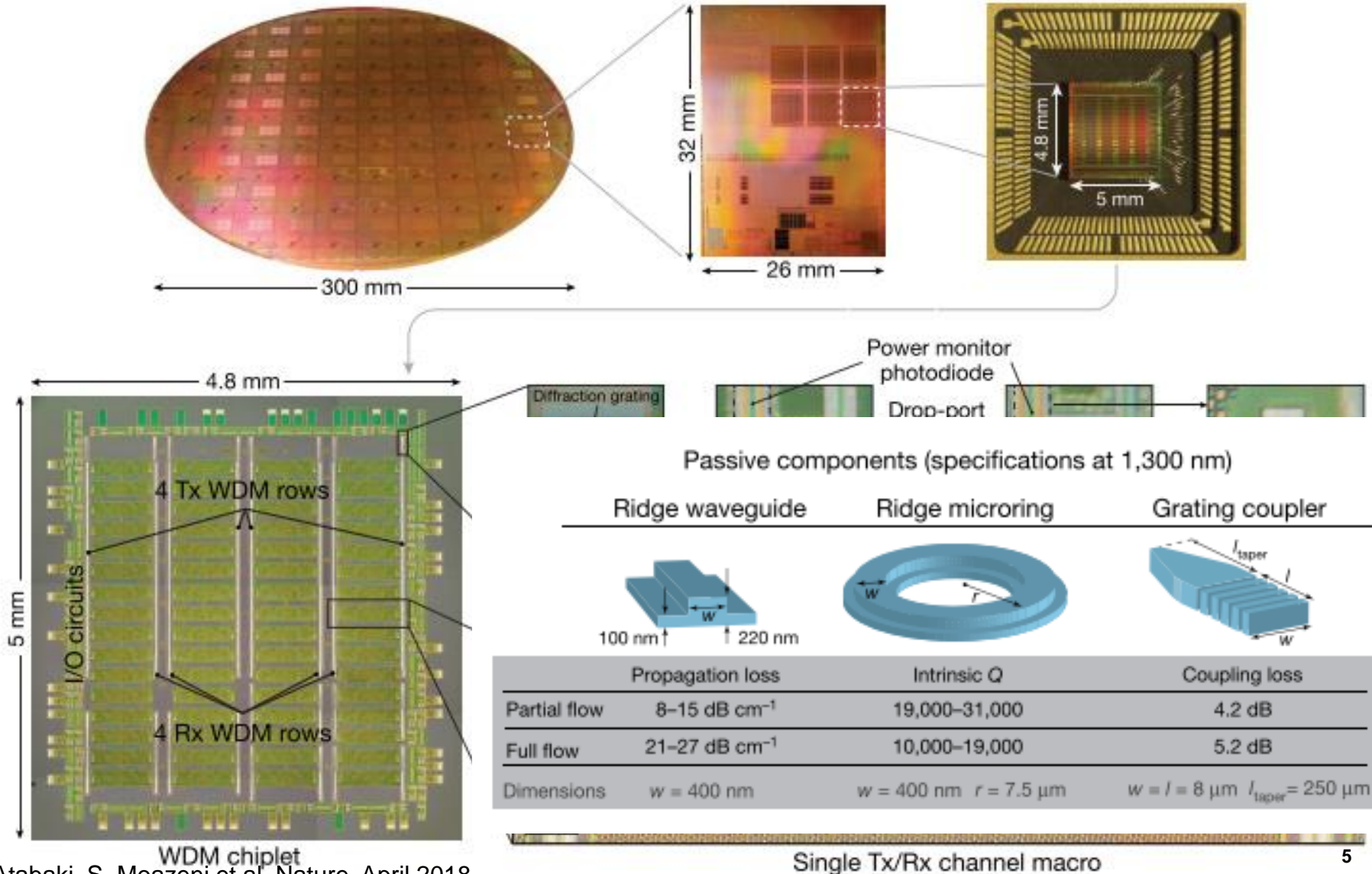
Many applications of Si photonics

From Jean Louis Malinge

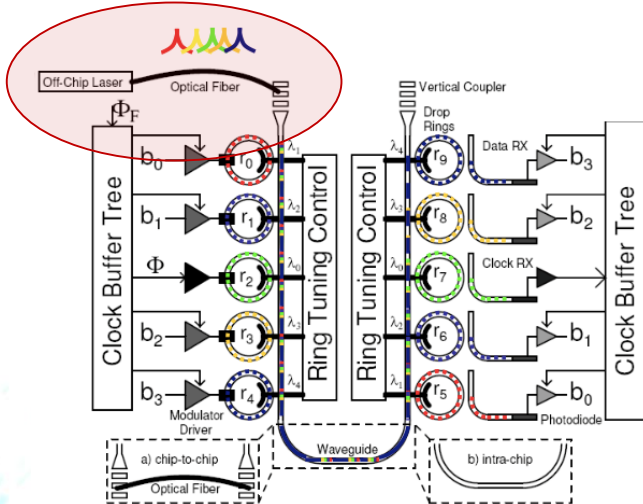


SiPh already in a 300mm fab

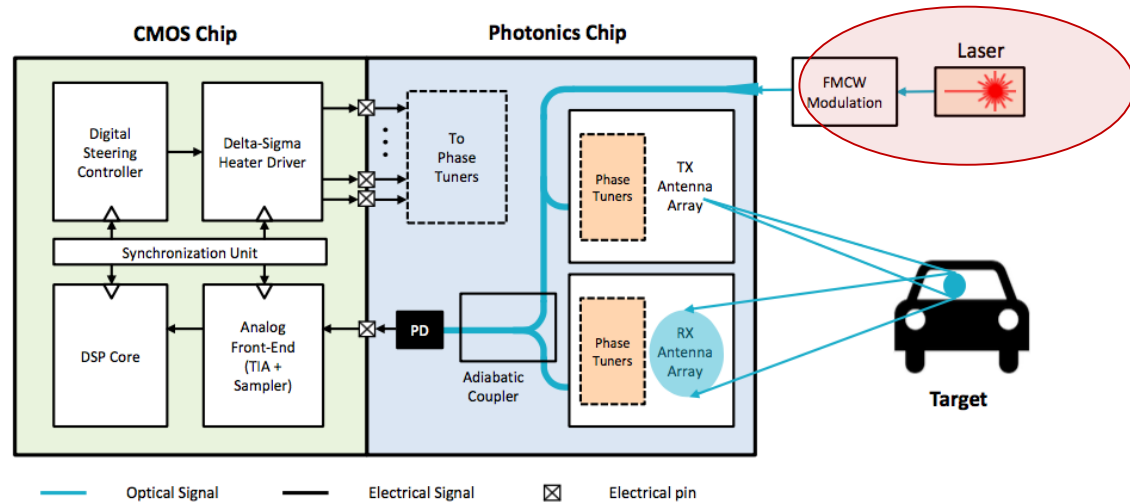
First 65nm bulk CMOS wafers with working photonics and transistors!



The biggest limitation of Si photonics

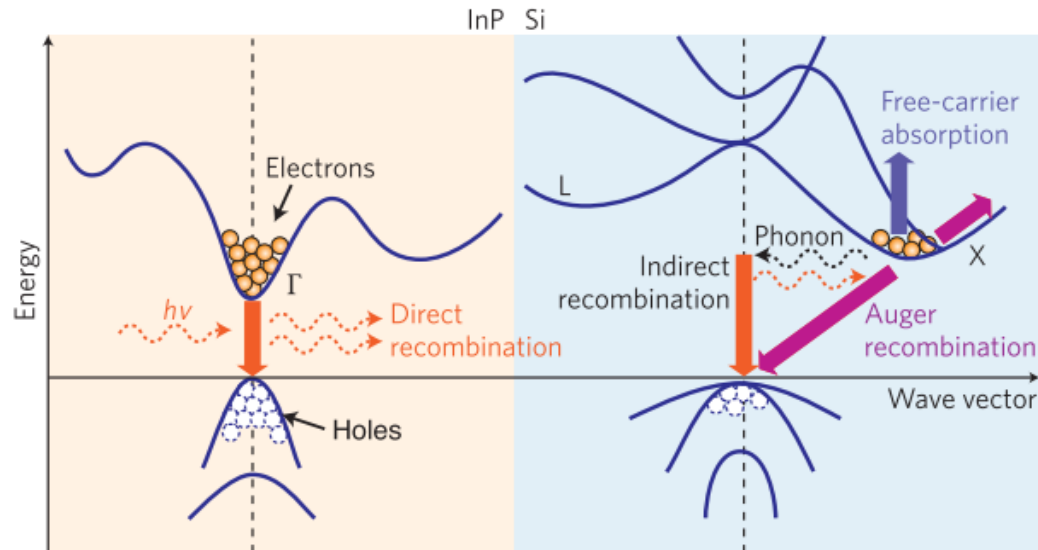


Integrated photonic interconnects

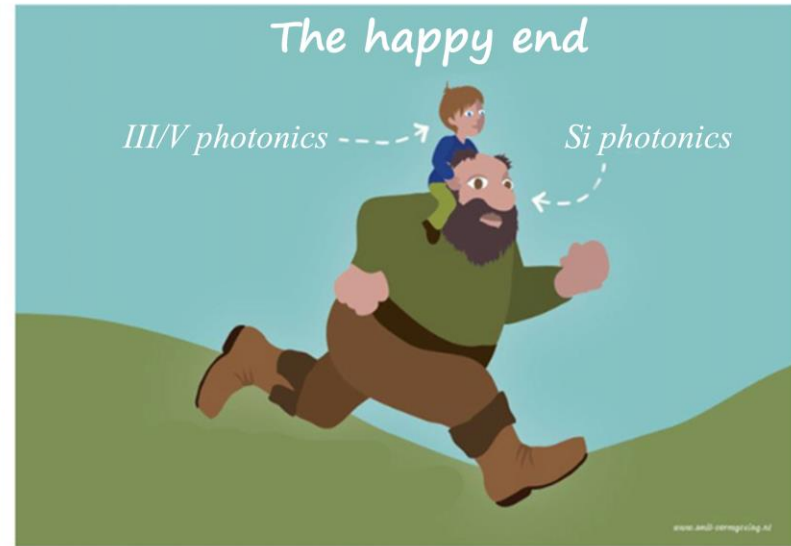


FMCW LIDAR – System Architecture

Indirect bandgap nature limits silicon to realize efficient light sources on-chip!



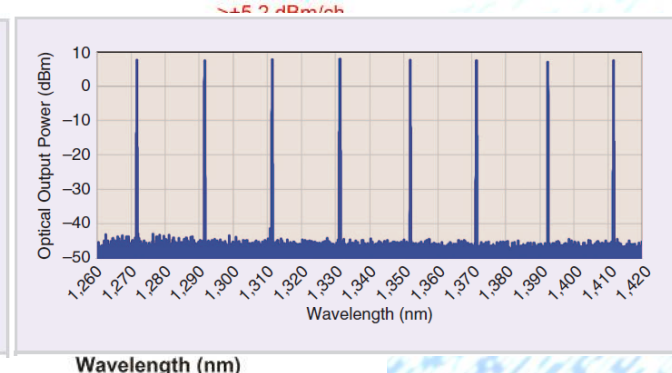
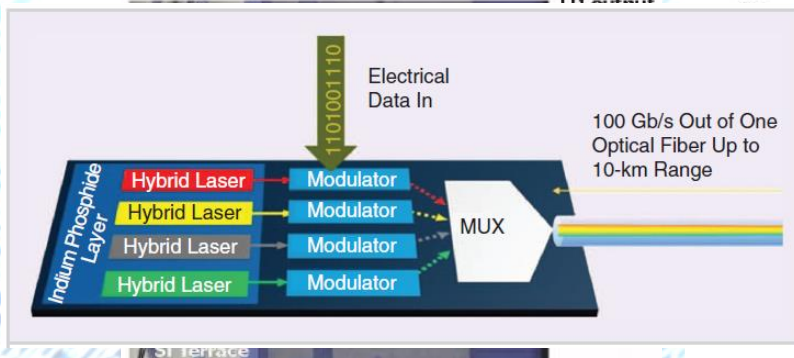
Efficient ways to generate light on Si



M. Smit, et al, Semicond. Sci. Technol., 2014

❖ Mature light source technology

➤ Flip-chip bonding/wafer bonding

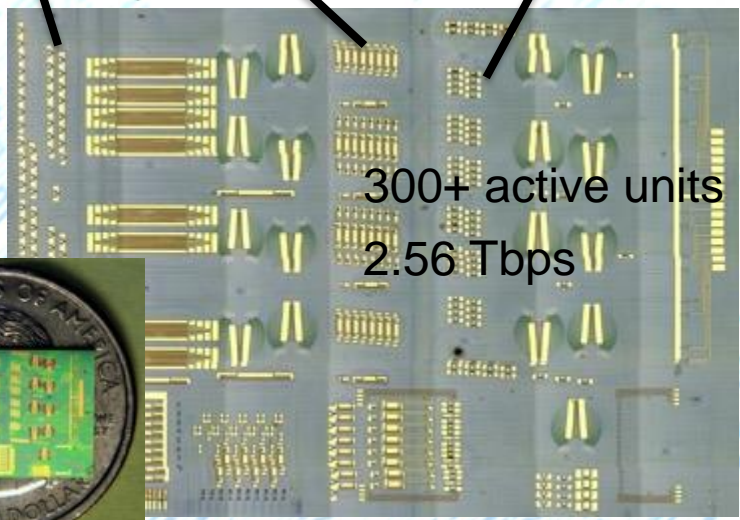


R. Jones et al., IEEE Nanotechnology Magazine, April 2019.
S. Tanaka et al., ECOC, Cannes, 2014.

Current status of the heterogeneously integrated lasers on Si



UCSB largest integration demonstration

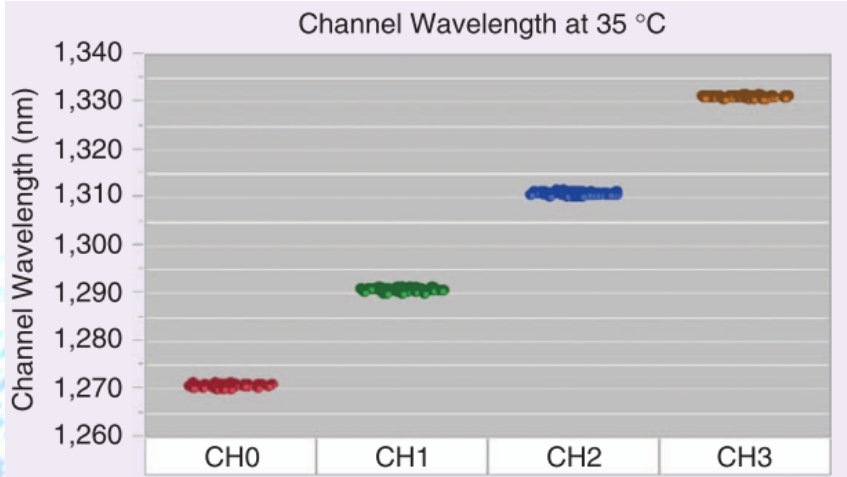


300+ active units
2.56 Tbps

Zhang et al. Optica (2016)

Intel ships the Si transceiver to the market

using their own commercial 300-mm wafer fabrication process.



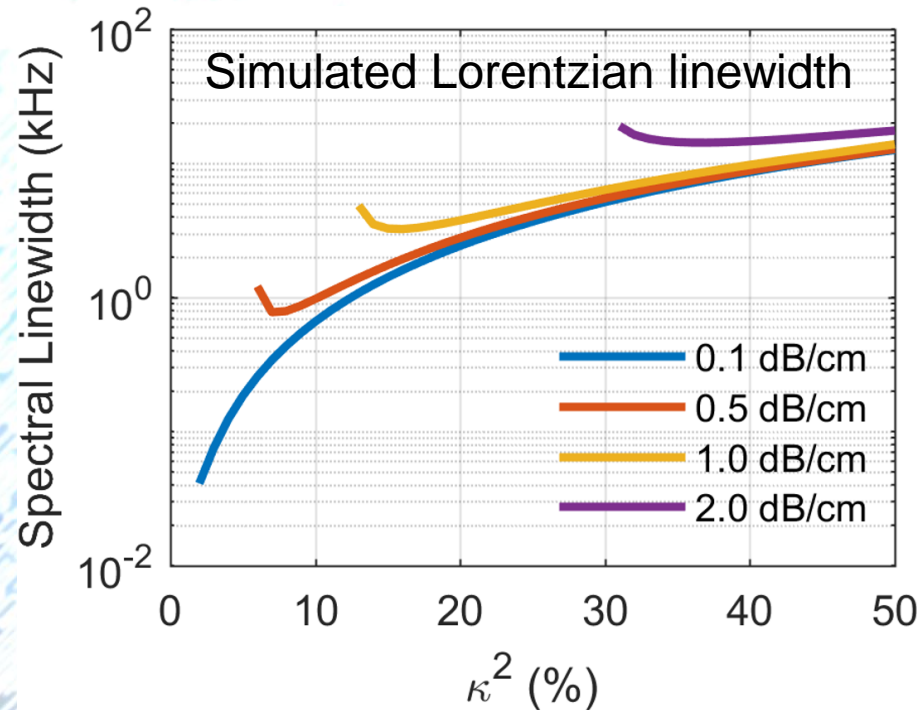
R. Jones et al., IEEE Nanotechnology Magazine, April 2019.

Further improvement in terms of optical linewidth

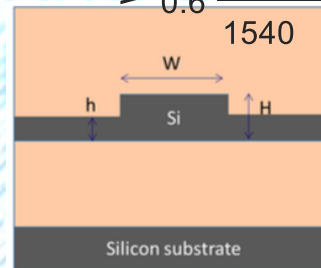
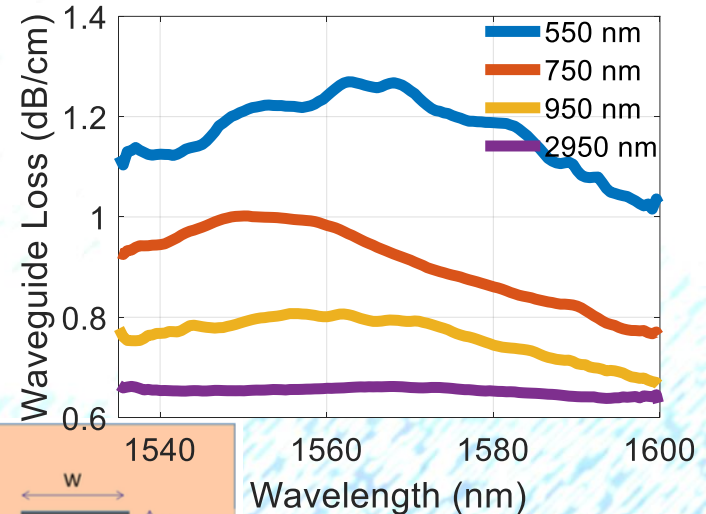
Modified Schawlow Townes Henry linewidth equations:

$$\Delta \nu_0 = \frac{q\omega^2 n_{sp}}{2Q^2 (I - I_{th})} (1 + \alpha^2)$$

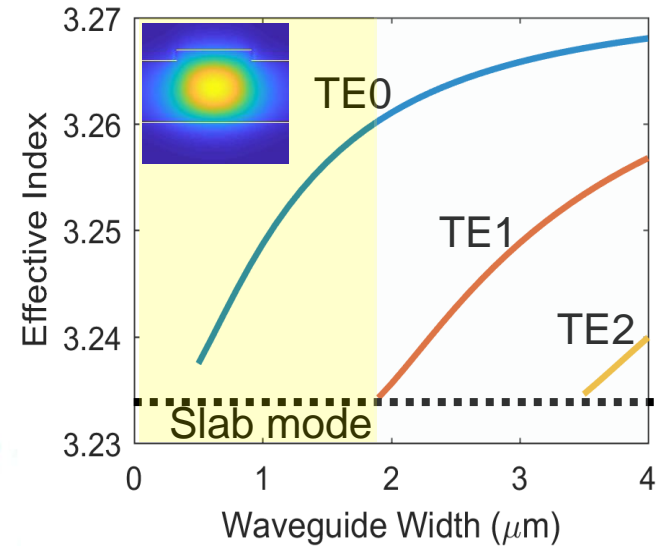
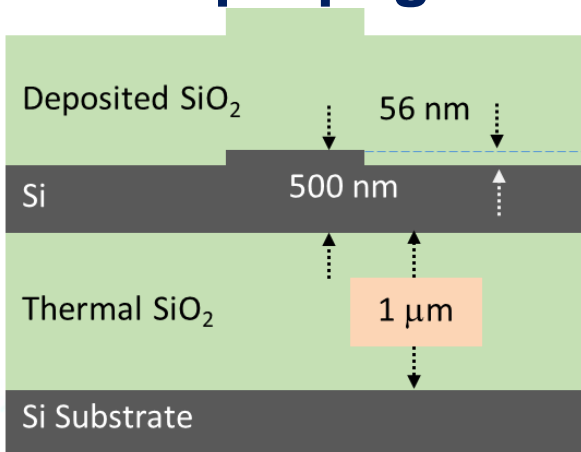
- Increase Q – cold cavity quality factor, governed by the internal loss
- Reduce I_{th}
- Reduce n_{sp}, α



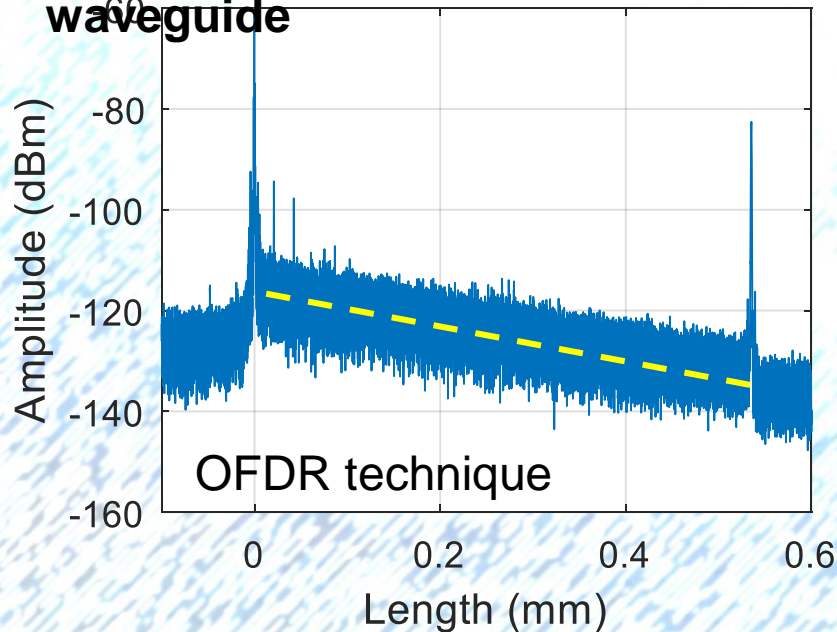
Measured Data on 231 nm Etched WG



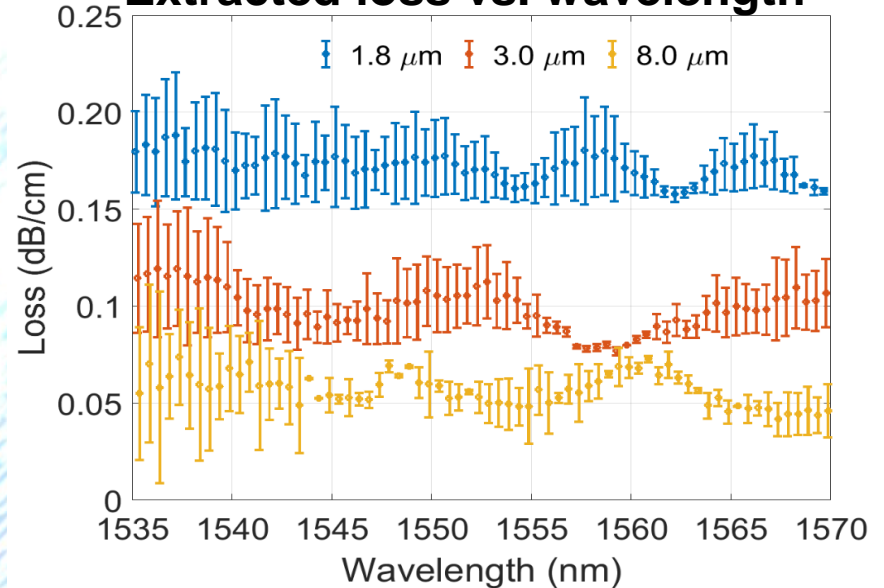
0.16 dB/cm propagation loss Si waveguide



Measured OBR trace of 1.8 μm waveguide



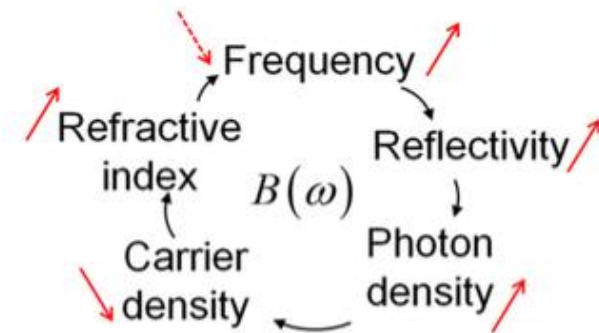
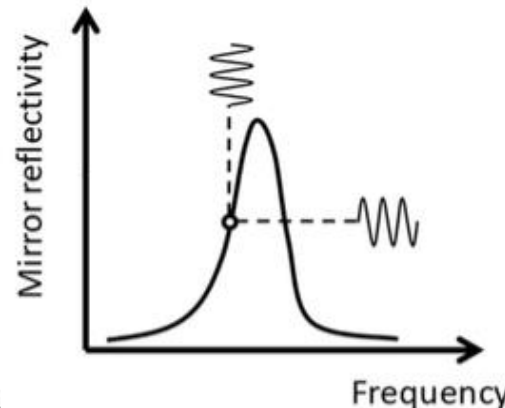
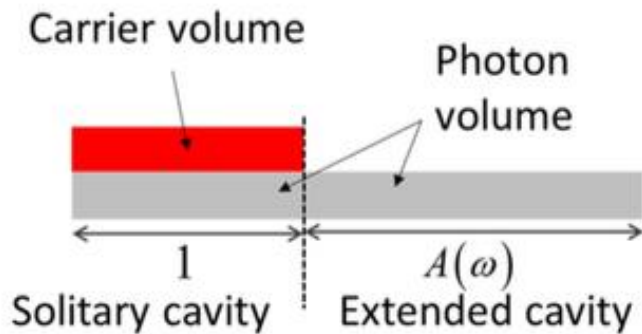
Extracted loss vs. wavelength



One more step to improve the optical linewidth

$$\Delta \nu = \frac{\Delta \nu_0}{F^2} \quad F = 1 + A + B \quad A = -\frac{1}{\tau_{in}} \frac{d\phi_{eff}(\omega)}{d\omega} \quad B = \frac{\alpha_H}{\tau_{in}} \frac{d}{d\omega} (\ln |r_{eff}(\omega)|)$$

- Reduce $\Delta \nu_0$
- Increase A - Extended cavity length/ active length
- Increase B - Negative feedback effect (detuned loading)

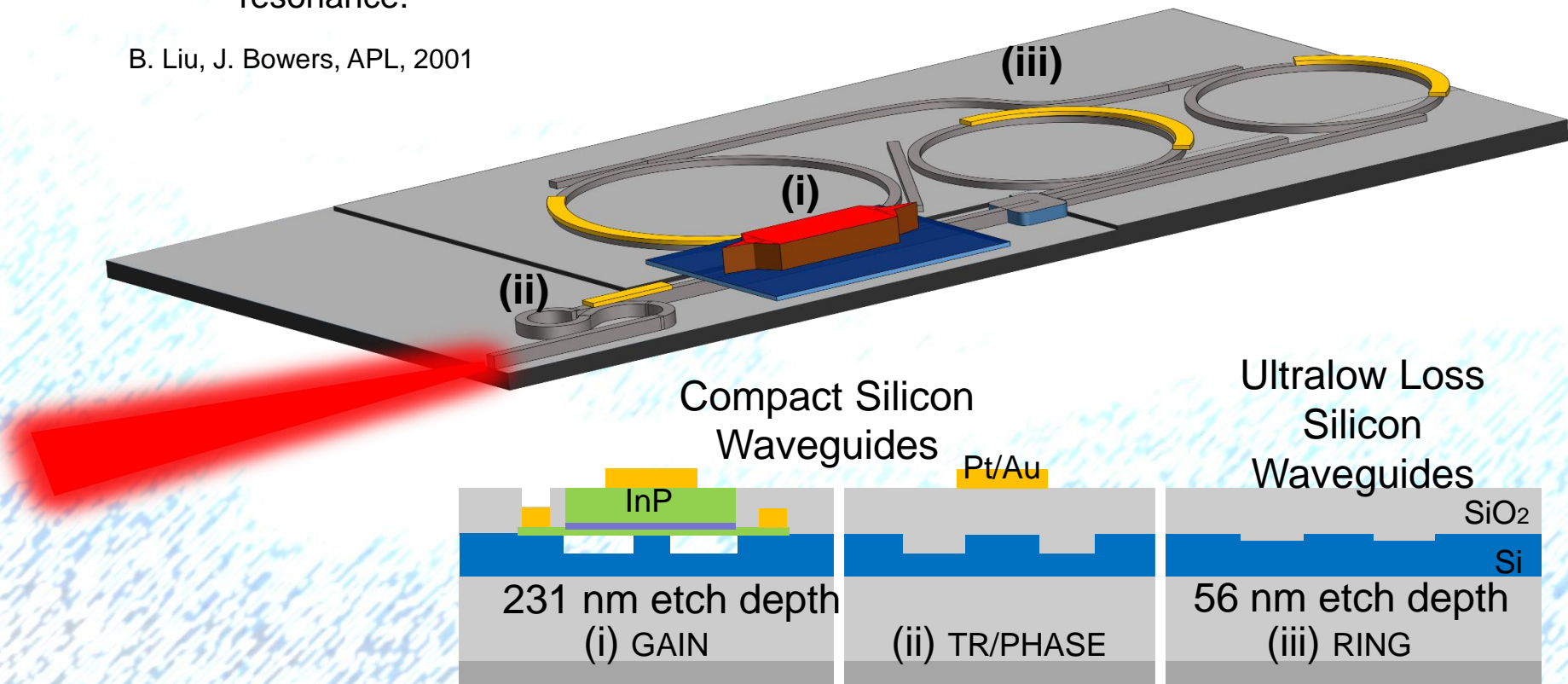


Ring Resonator Coupled Lasers

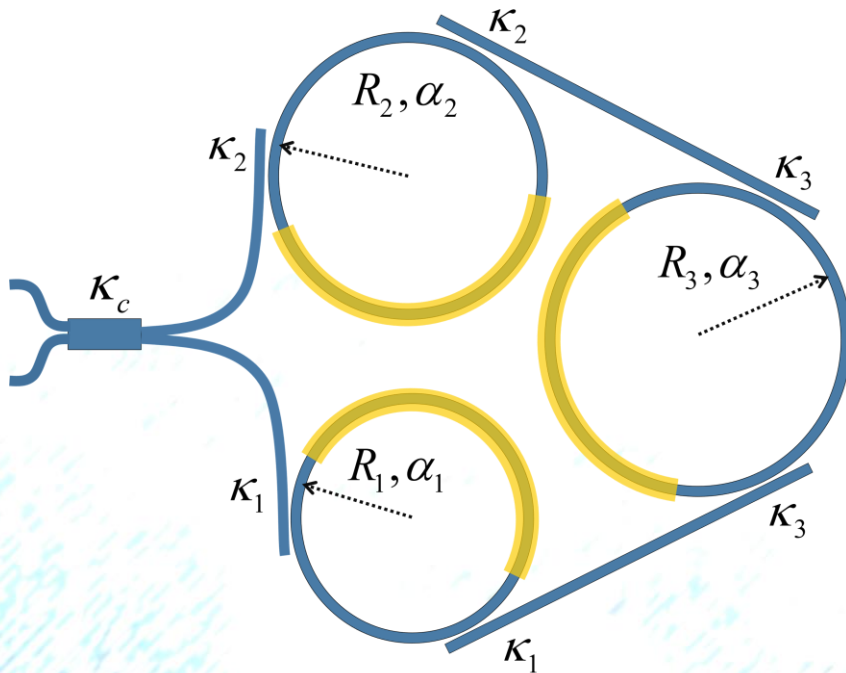
Using rings inside the cavity benefits the linewidth in two ways:

- **Resonance cavity length enhancement**
 - increasing the photon lifetime due to effective cavity length enhancement.
- **Negative optical feedback**
 - providing negative optical feedback by slight detuning from the ring (resonator) resonance.

B. Liu, J. Bowers, APL, 2001



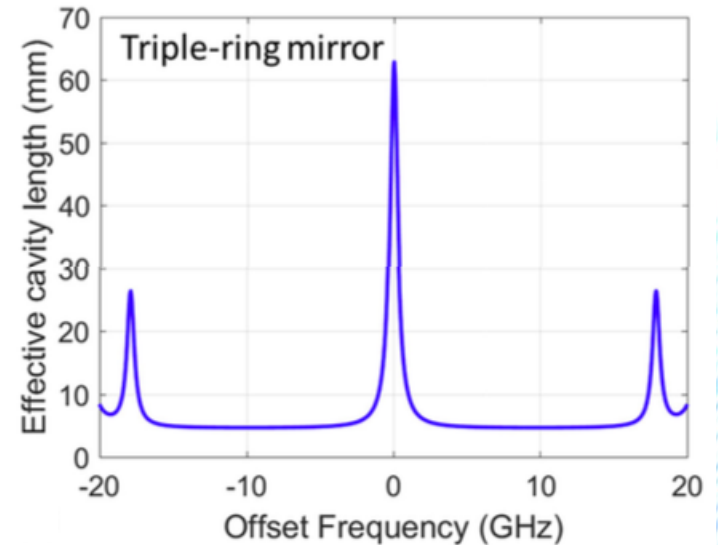
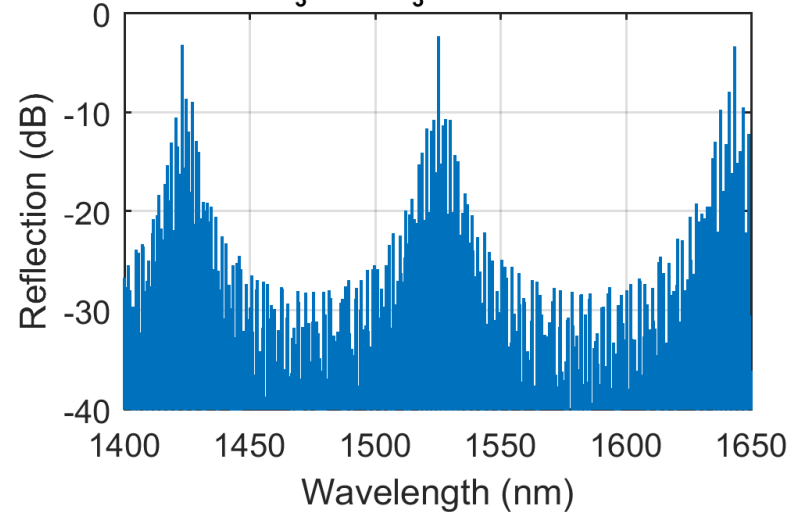
Ring Resonator Coupled Lasers



- Designed Vernier FSR = 114 nm
- ✓ Passive SMSR > 8 dB across the whole tuning range

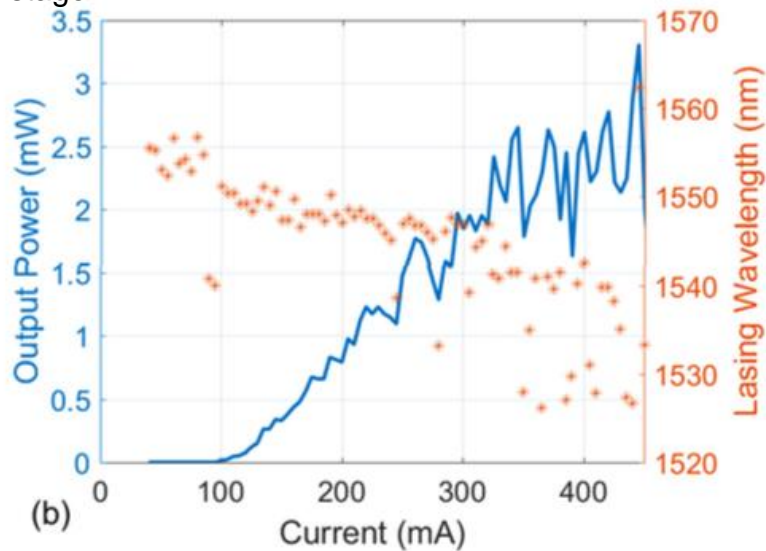
$$\kappa_c^2=0.5, \kappa_1^2=\kappa_2^2=0.09, R_1=599.9666\mu\text{m}, R_2=600.8558\mu\text{m}, \alpha=0.18\text{dB/}$$

$$\kappa_3^2=0.09, R_3=707.5652\mu\text{m}$$

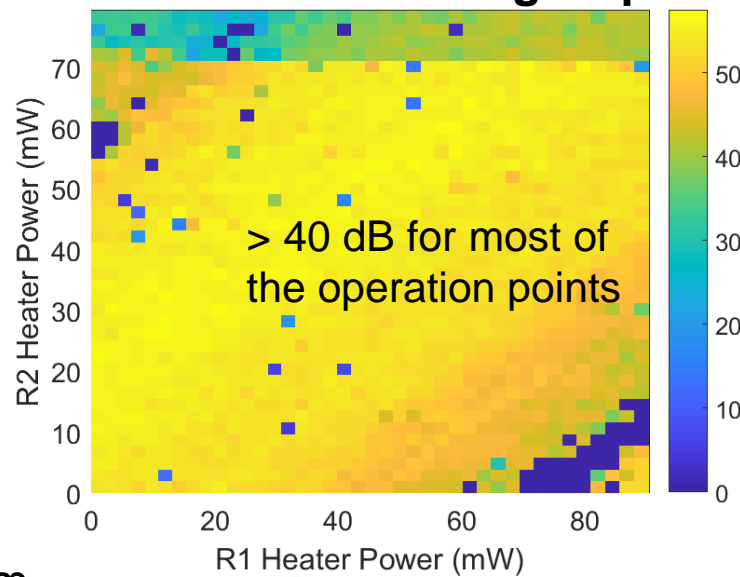


Laser performance characterization

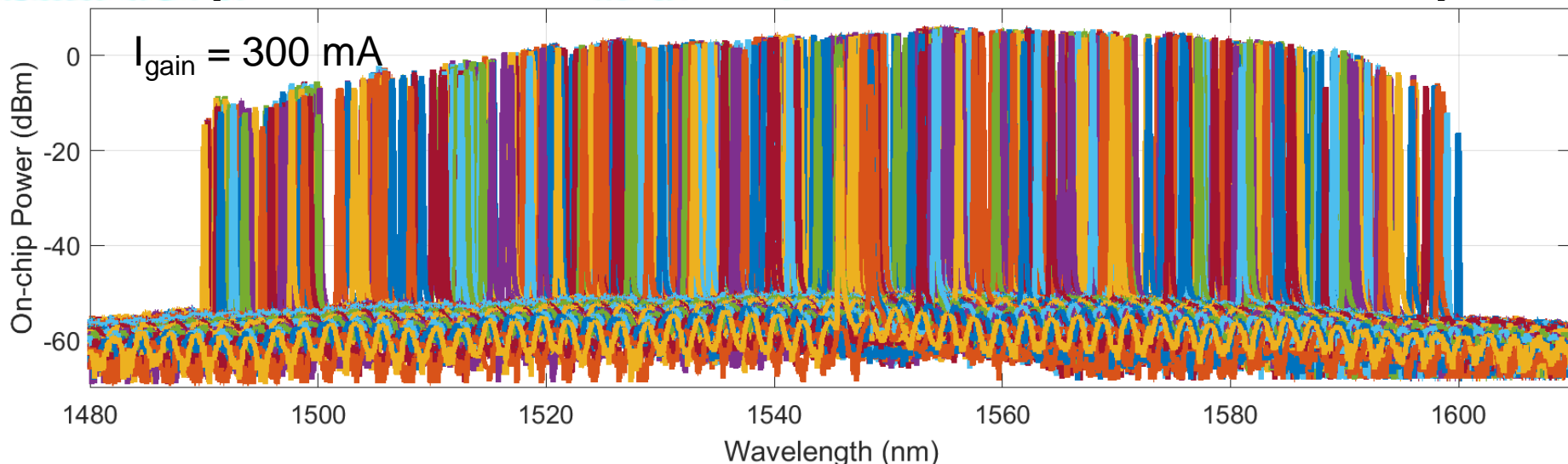
$T_{\text{stage}} = 20\text{ }^{\circ}\text{C}$



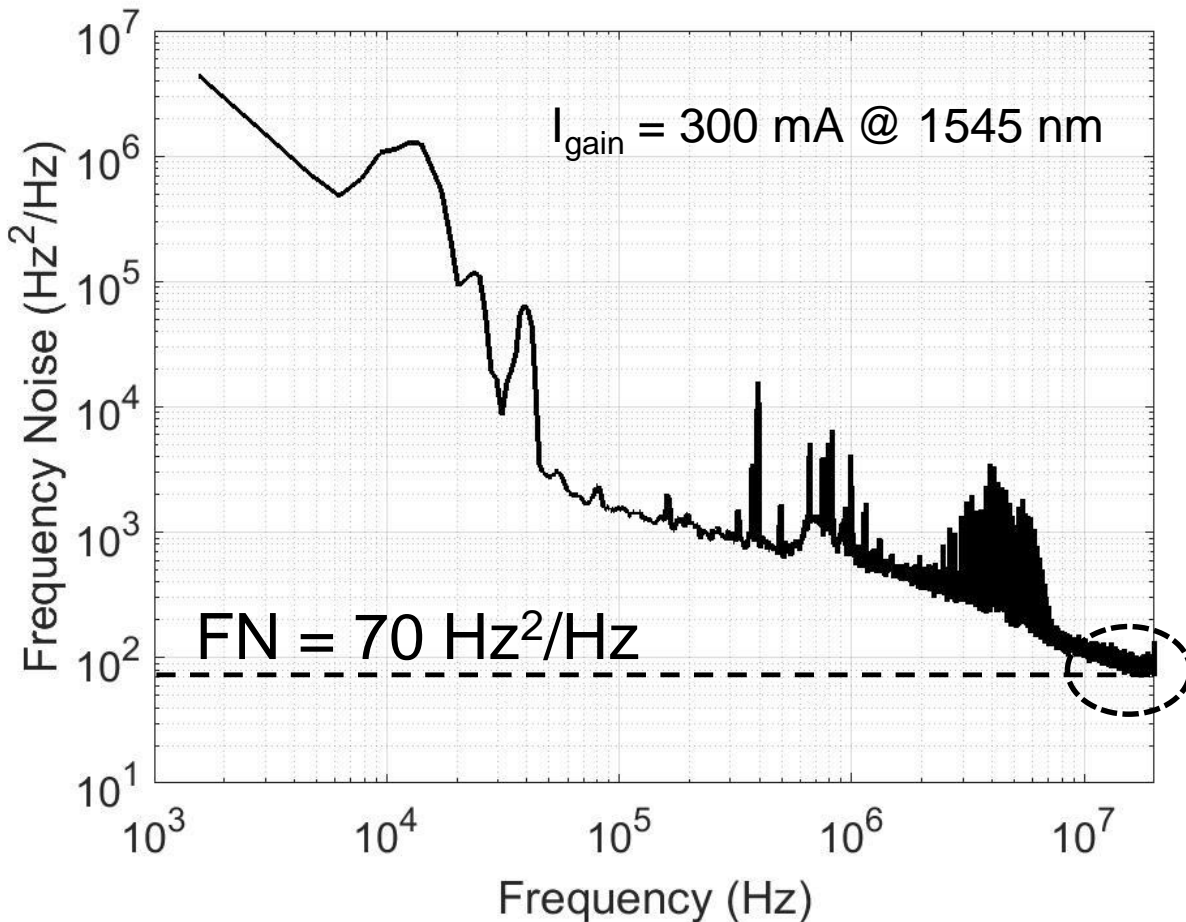
SMSR on Tuning Map



110 nm



Frequency Noise and Lorentzian Linewidth



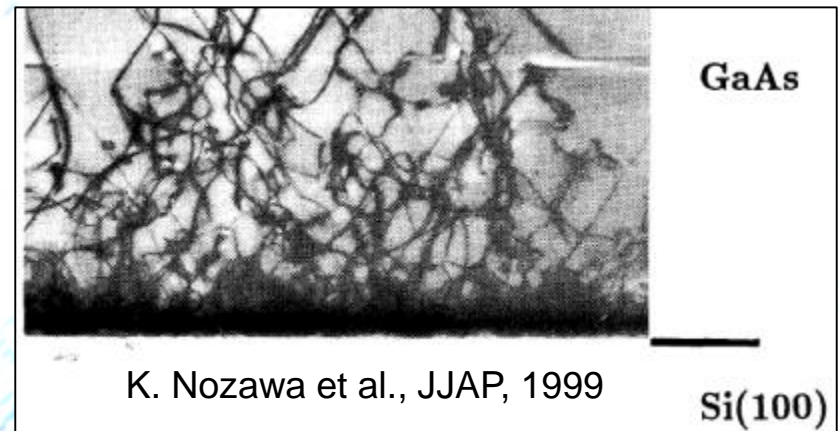
- Measurement setup is limited. The noise spectrum has not flattened at 20 MHz yet.
- Lorentzian Linewidth **< 220 Hz !**

Emerging light source technology by direct epitaxial growth



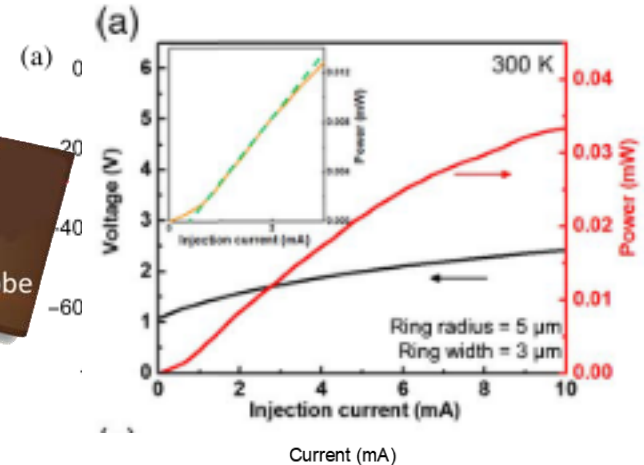
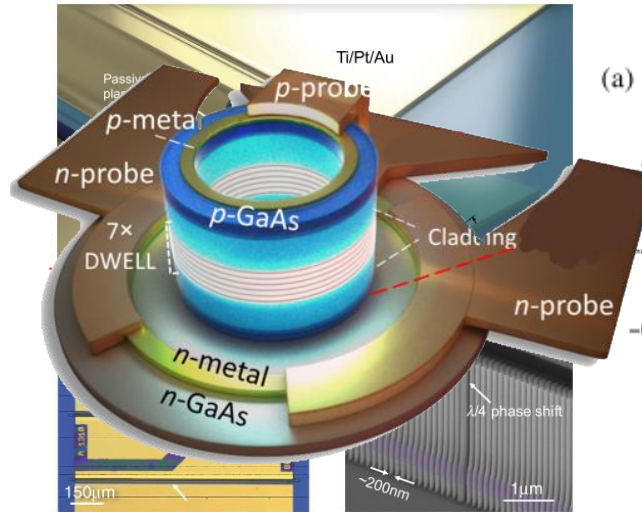
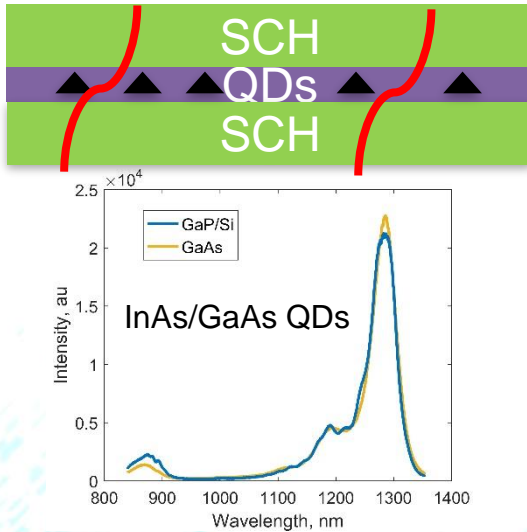
Monolithic Growth is Difficult

- Lattice constant mismatch
 - High density of dislocations, antiphase domains, stacking faults
- Thermal expansion mismatch
 - Cracking, residual strain at room temperature



Tremendous progress in the last five years

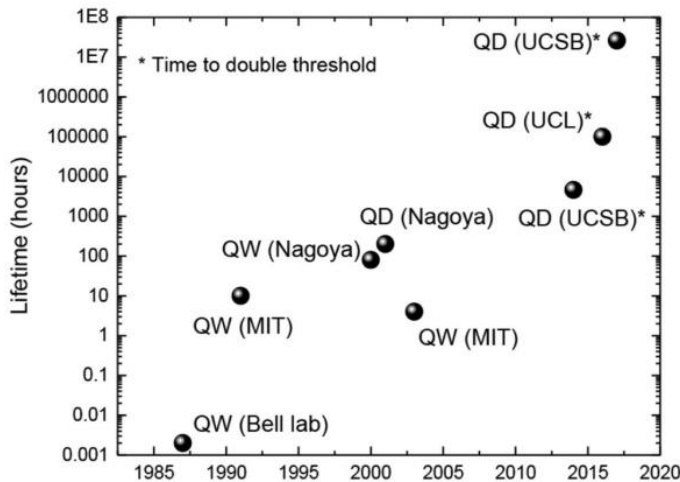
Maturation of the Light Source



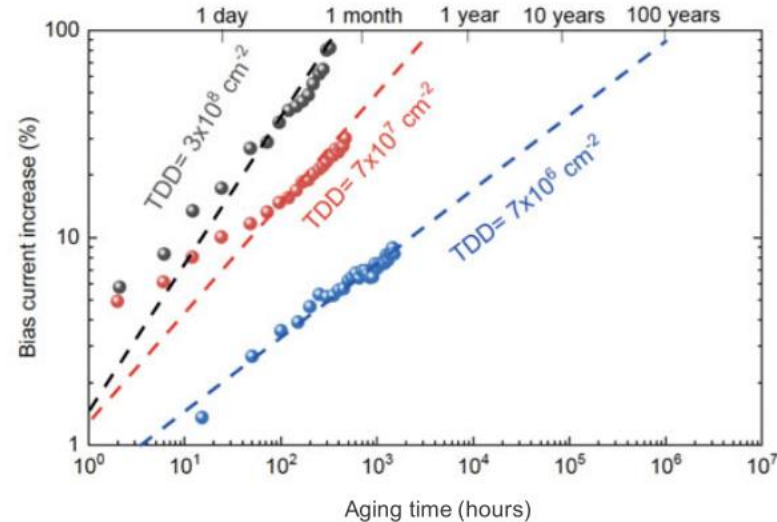
Y. Wan, et al, Optica, 2018
Y. Wang, et al, Optica, 2018

D. Jung, et al, ACS photonics, 2018

Demonstrating Reliable Operation



A. Liu, J. Bowers, IEEE JSTQE, 2018



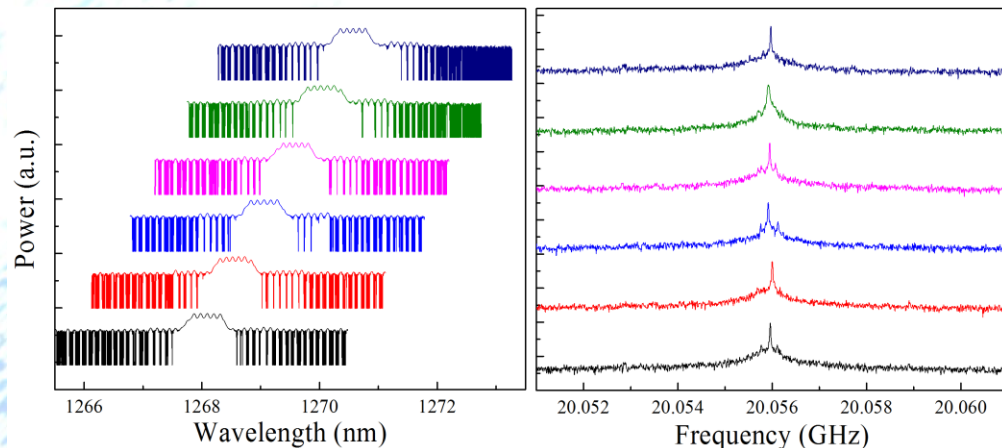
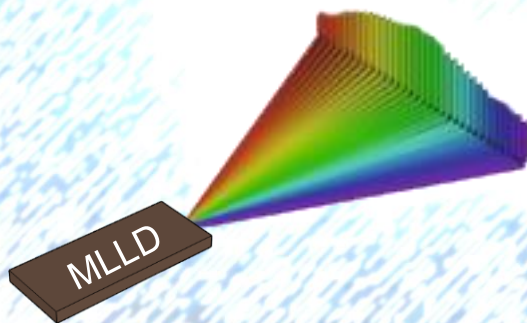
Advantage of the quantum dots

Quantum dots have advantages over Quantum well or bulk material

- ✓ inhomogeneously broadened gain spectrum
- ✓ ultrafast carrier dynamics
- ✓ superior temperature stability
- ✓ high saturation output power
- ✓ better back-reflection insensitivity
- ✓ low level of amplified spontaneous emission (ASE) noise

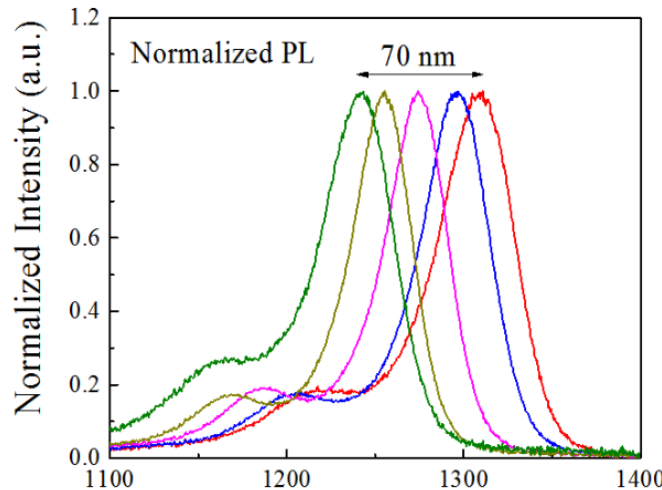
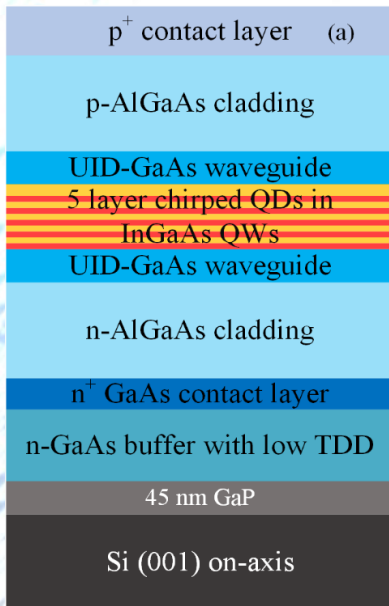
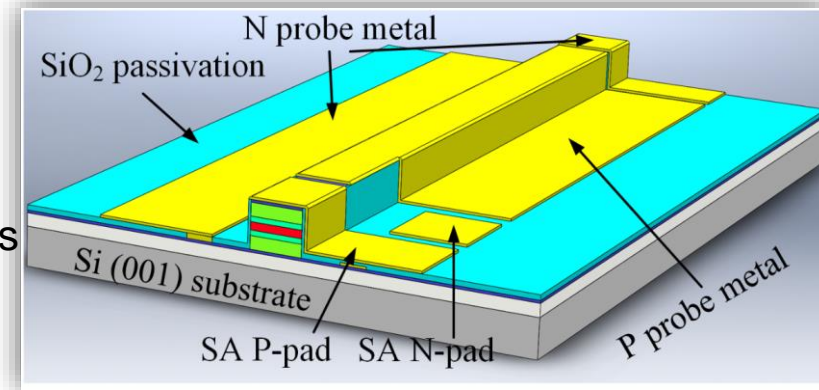
Excellent material for making mode locked lasers!

- **Simple structure to generate a wide coherent spectrum with a fixed channel spacing**

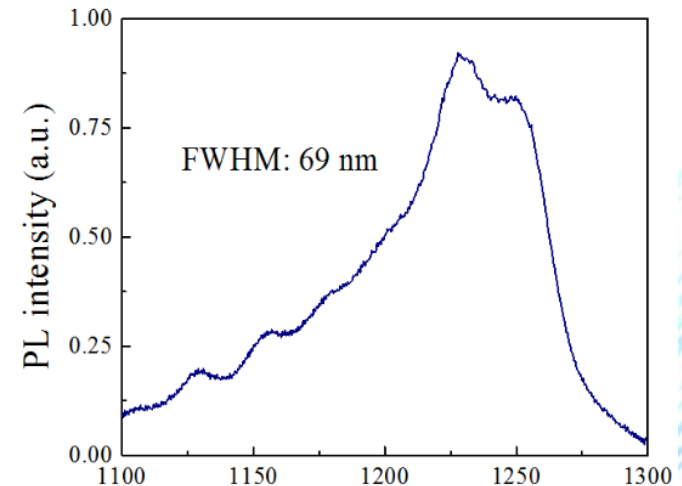


Mode locked laser device design

- Two section mode locked laser design
 - 3 μm ridge width
 - 2048 μm cavity length
 - SA section length is 14% of the total cavity length
- Active region: chirped five stacks of InAs QD layers
 - P modulation doped $5 \times 10^{17} \text{ cm}^{-3}$ in the spacer layer
 - TDD as low as $7 \times 10^6 \text{ cm}^{-2}$
 - Chirped QD layers for broadened FWHM of 69 nm



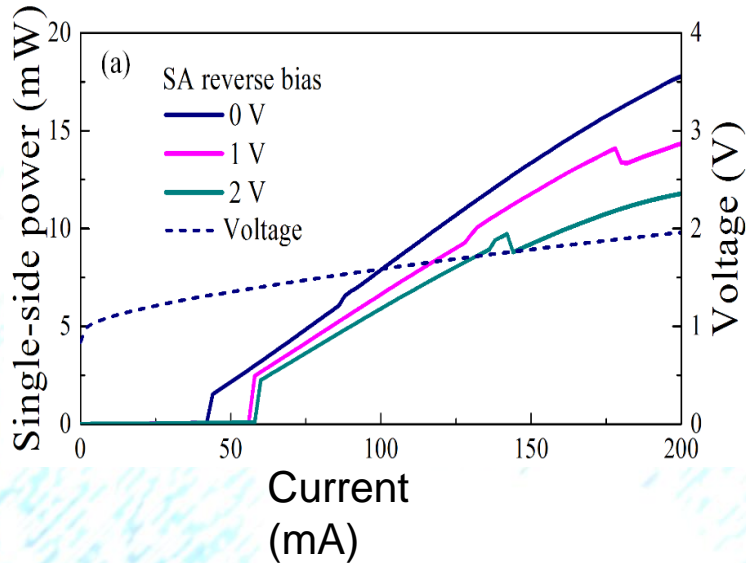
PL emission spectra of a single InAs DWELL layer with different InGaAs thicknesses in test run



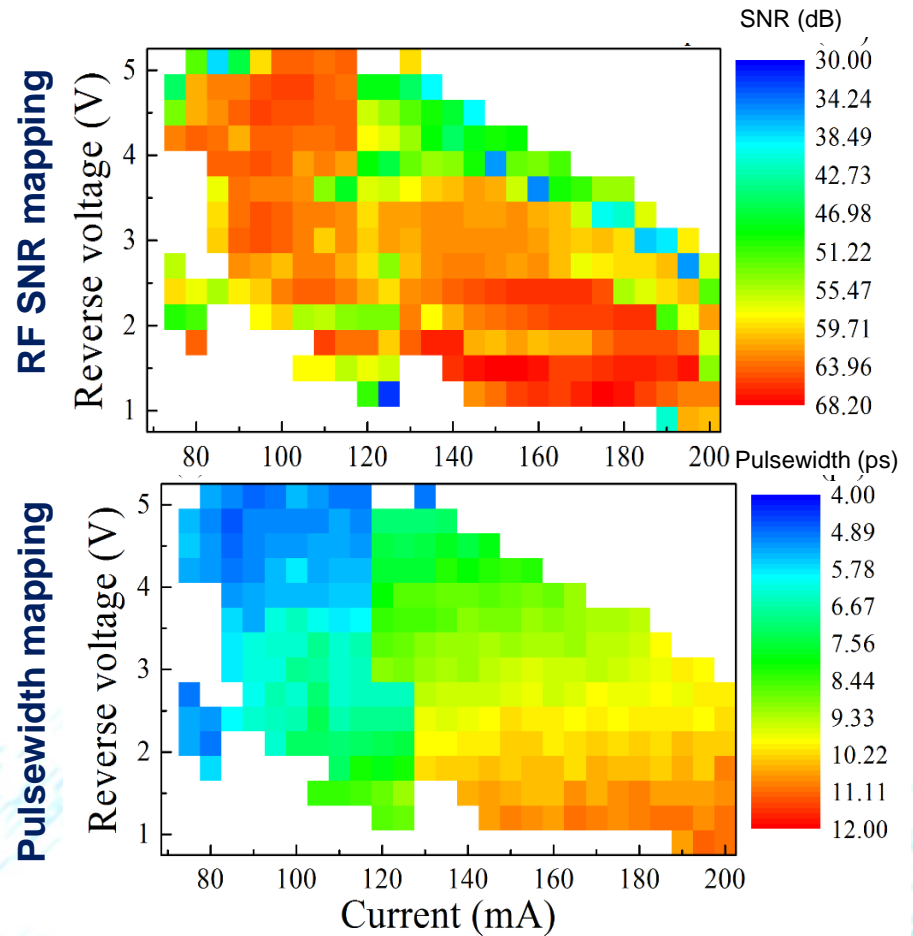
PL spectrum of the material used.

Basic device performance

L-I-V curve



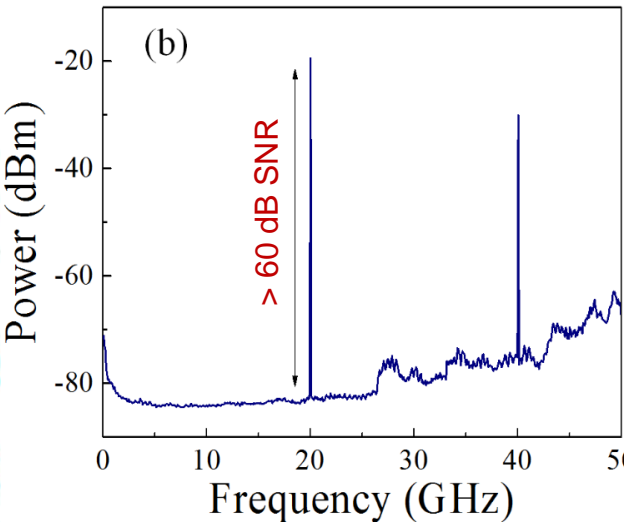
- Threshold: increase from 42 mA to 58 mA as SA section reverse bias increase
- Series resistance: $\sim 3.2 \Omega$



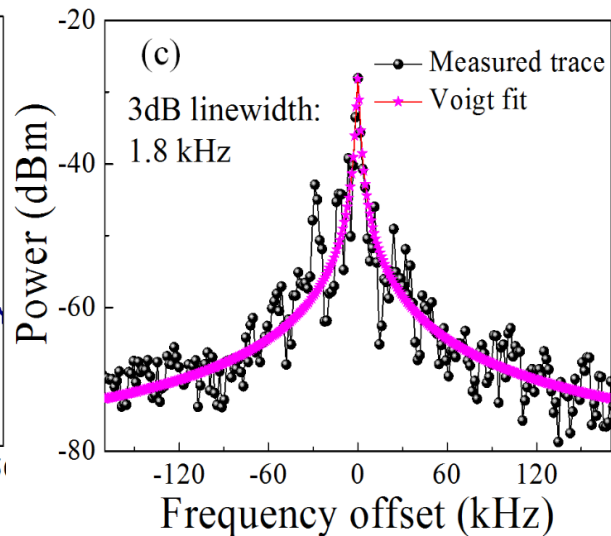
- Mode locking criterion: being restricted to fundamental frequency tone signal to noise floor (SNR) ratio larger than 30 dB with the pulse width narrower than 12 ps.
- **Wide mode locking regime** is demonstrated.

Basic device performance

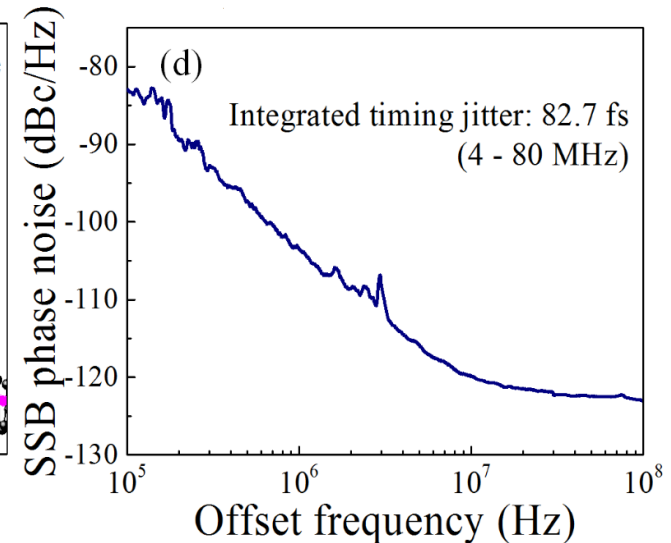
RF spectrum



RF peak with Voigt fit

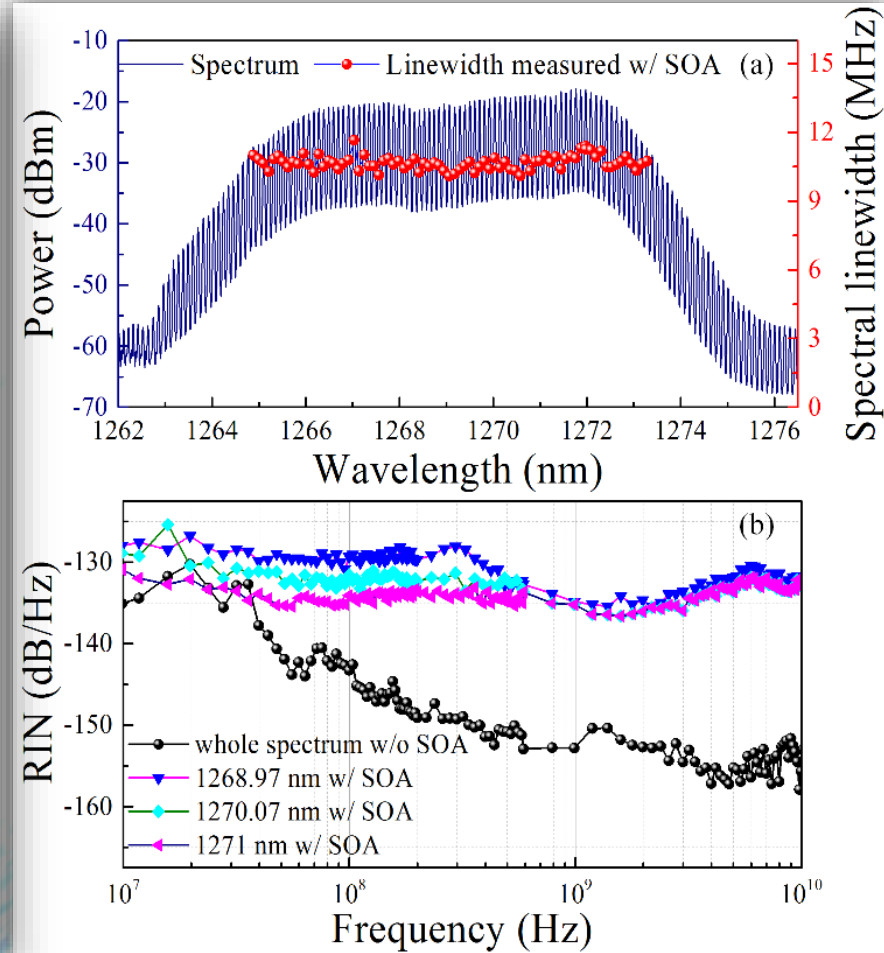
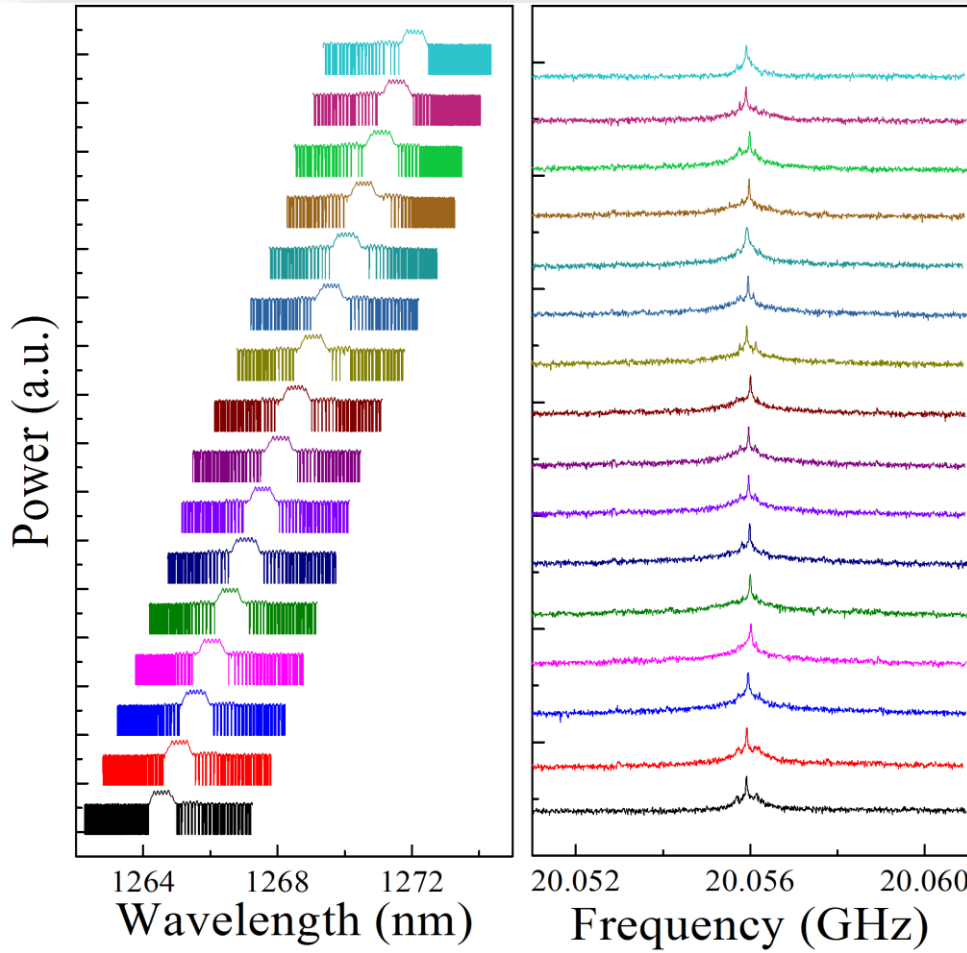


SSB phase noise plot



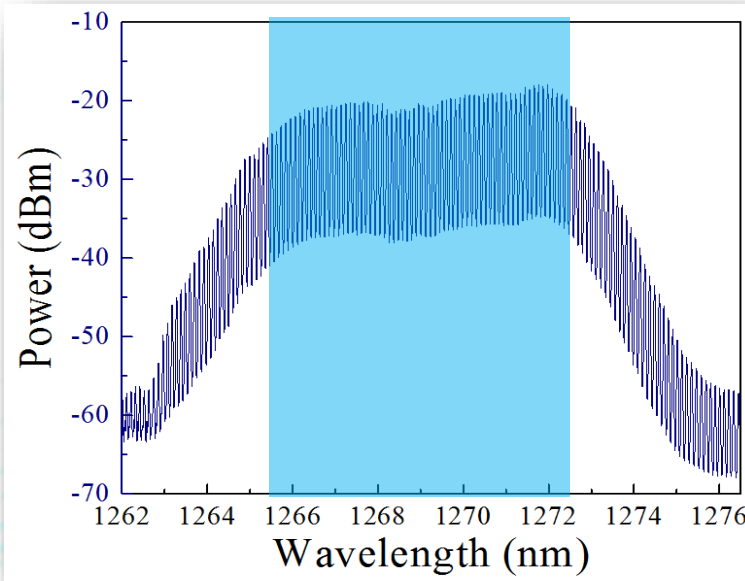
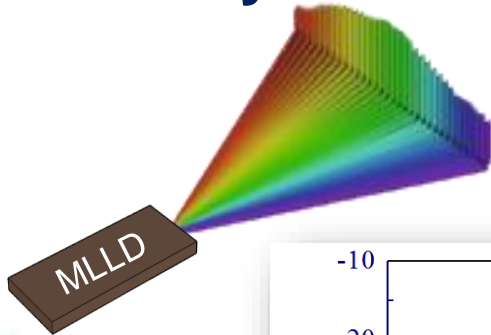
- A sharp fundamental RF tone at 20.02 GHz with a SNR of 64 dB and its higher-order harmonic can be clearly seen across the 50 GHz span, indicating very stable mode locking operation.
- The 3 dB RF linewidth is 1.8 kHz with a Voigt fit.
- The integrated timing jitter is 82.7 fs from 4 to 80 MHz of the ITU-T specified range, which is the lowest timing jitter ever reported to date for any passively mode-locked semiconductor laser diode.

Basic device performance

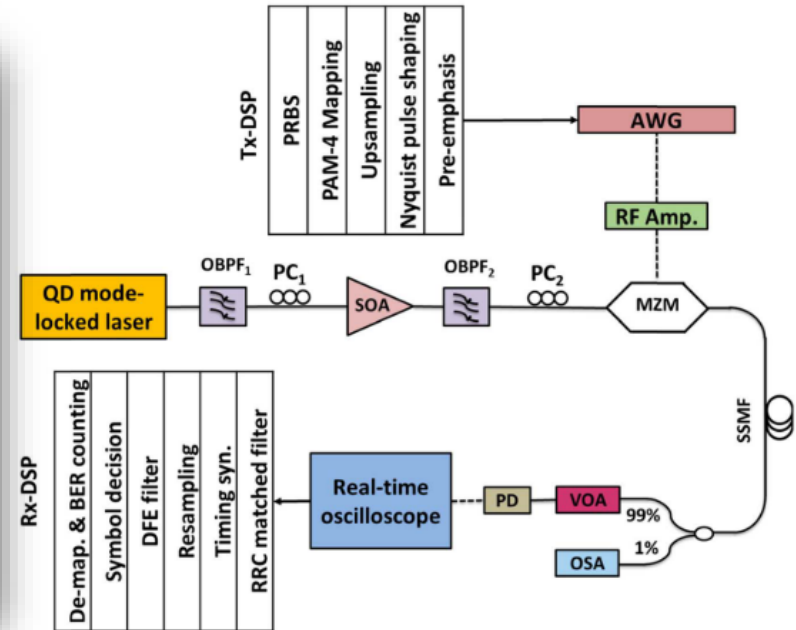


$I_{\text{gain}} = 180 \text{ mA}$, $V_{\text{SA}} = -1.92 \text{ V}$

PAM-4 system level transmission demonstration



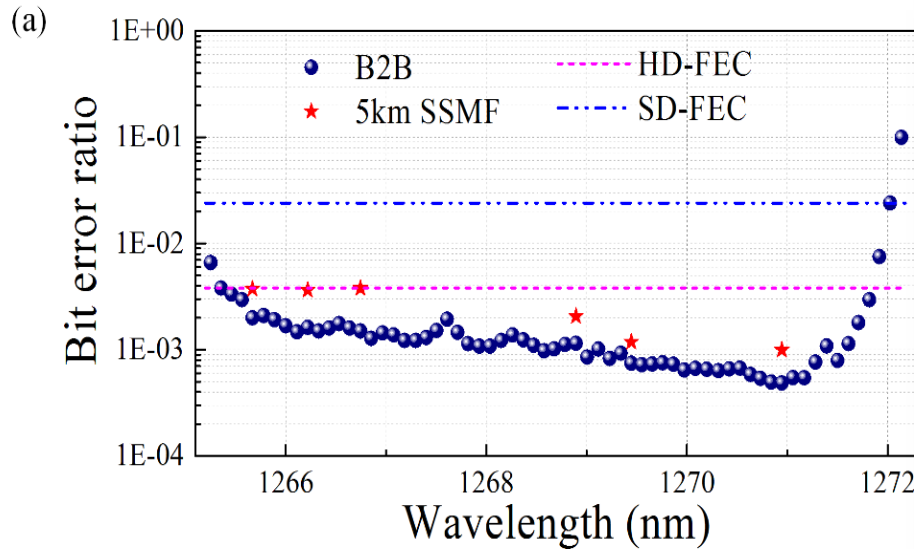
System-level PAM-4 transmission test setup



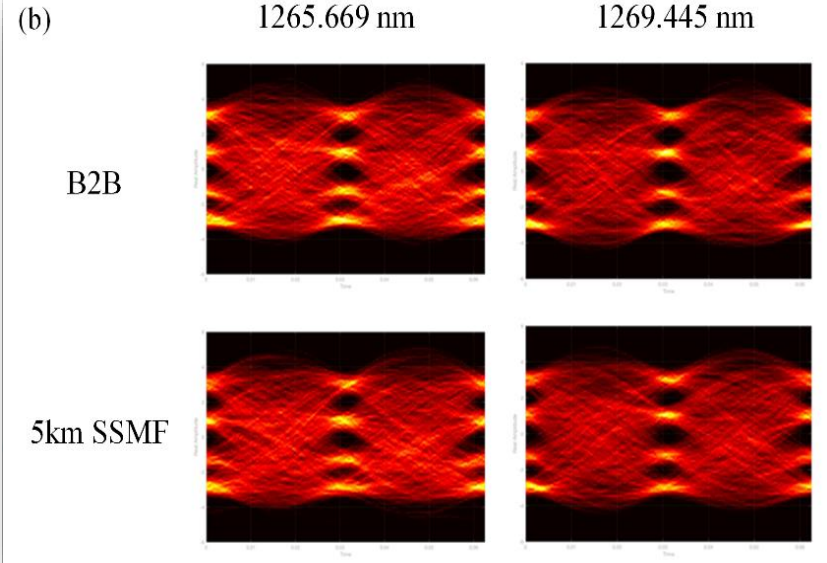
[1] X. Wu, S. Liu, D. Jung *et al.*, "Terabit interconnects with a 20-GHz O-band passively mode locked quantum dot laser grown directly on silicon", OFC, 2019
 [2] S. Liu, X. Wu, D. Jung *et al.*, "High-channel-count 20 GHz passively mode-locked quantum dot laser directly grown on Si with 4.1 Tbit/s transmission capacity", Optica, 2019

4.1 Tbps 64-wavelength 32 Gaud PAM-4 Demonstration

BER performance



PAM-4 eye diagram



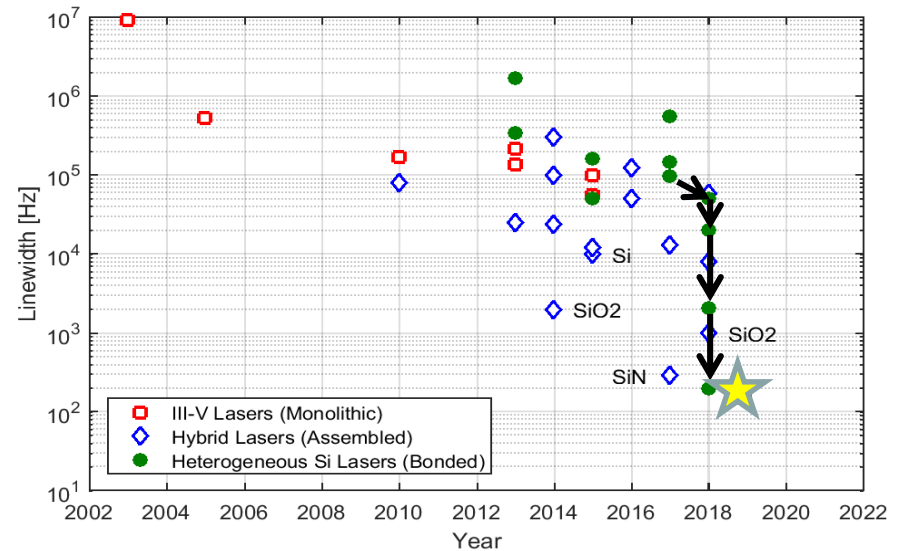
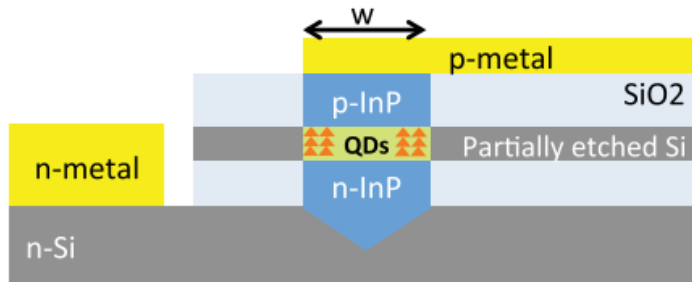
- 64 channels are utilized.
- 32 Gbaud Nyquist pulse shaped PAM-4 modulation format.
- With 61 channels below hard-decision FEC threshold and total 64 channels below soft-decision FEC threshold.
- An aggregate total transmission capacity is **4.1 terabits per second**.

Summary

❑ Integrated lasers on silicon can provide a high performance, low cost, mass production and high energy efficiency solution.

- ✓ Record ultralow noise chip-scale semiconductor lasers
- ✓ Record ultrawide wavelength tuning ranges for chip-scale lasers

❑ Epitaxial lasers are progressing fast.



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